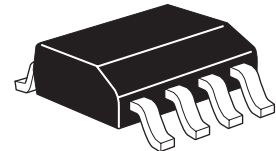


ZXMN6A11DN8

60V SO8 Dual N-channel enhancement mode MOSFET

Summary

$V_{(BR)DSS}$	$R_{DS(on)}$ (Ω)	I_D (A)
60	0.120 @ $V_{GS} = 10V$	3.2
	0.180 @ $V_{GS} = 4.5V$	2.6

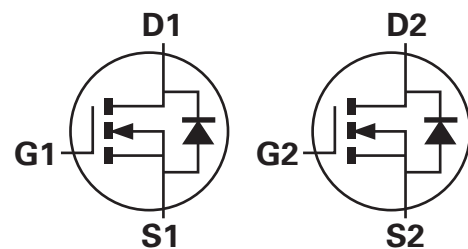


Description

This new generation trench MOSFET from Zetex features a unique structure combining the benefits of low on-resistance and fast switching, making it ideal for high efficiency power management applications.

Features

- Low on-resistance
- Fast switching speed
- Low threshold
- Low gate drive
- Low profile SOIC package

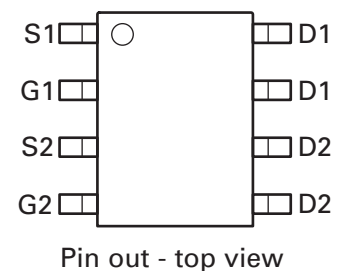


Applications

- DC-DC converters
- Power management functions
- Motor control

Ordering information

Device	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXMN6A11DN8TA	7	12	500



Device marking

ZXMN
6A11D

ZXMN6A11DN8

Absolute maximum ratings

Parameter	Symbol	Limit	Unit
Drain-source voltage	V_{DSS}	60	V
Gate-source voltage	V_{GS}	± 20	V
Continuous drain current @ $V_{GS} = 10V$; $T_{amb} = 25^{\circ}C^{(b)}$ @ $V_{GS} = 10V$; $T_{amb} = 70^{\circ}C^{(b)}$ @ $V_{GS} = 10V$; $T_{amb} = 25^{\circ}C^{(a)}$	I_D	3.2 2.6 2.5	A
Pulsed drain current ^(c)	I_{DM}	13.7	A
Continuous source current (body diode) ^(b)	I_S	3.1	A
Pulsed source current (body diode) ^(c)	I_{SM}	13.7	A
Power dissipation at $T_{amb} = 25^{\circ}C^{(a)(d)}$ Linear derating factor	P_D	1.25 10	W mW/ $^{\circ}C$
Power dissipation at $T_{amb} = 25^{\circ}C^{(a)(e)}$ Linear derating factor	P_D	1.8 14	W mW/ $^{\circ}C$
Power dissipation at $T_{amb} = 25^{\circ}C^{(b)(d)}$ Linear derating factor	P_D	2.1 17	W mW/ $^{\circ}C$
Operating and storage temperature range	T_j, T_{stg}	-55 to +150	$^{\circ}C$

Thermal resistance

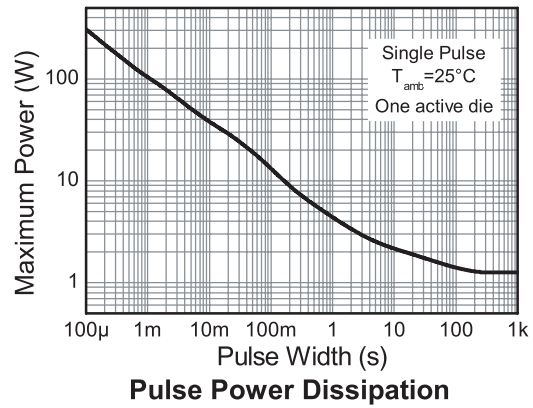
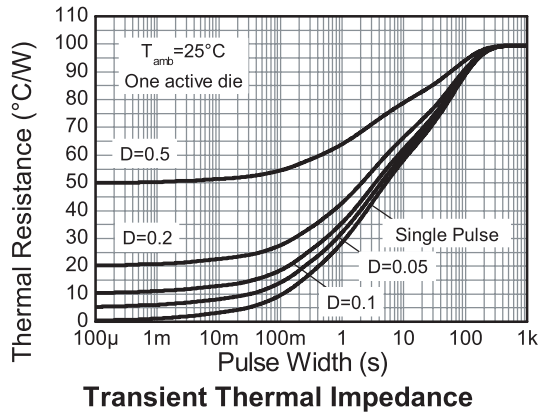
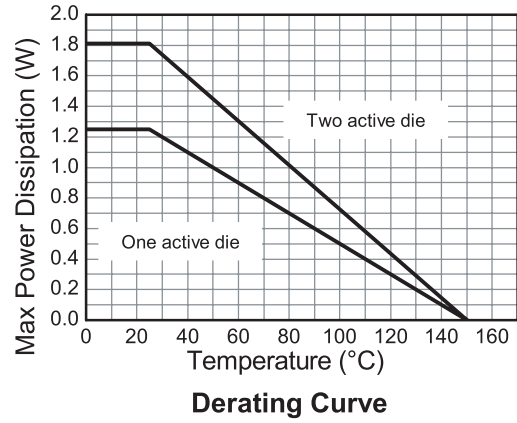
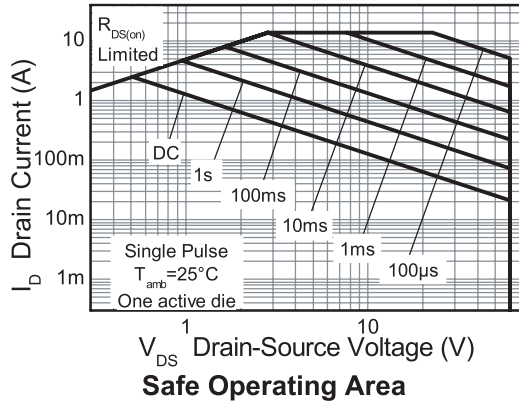
Parameter	Symbol	Limit	Unit
Junction to ambient ^{(a)(d)}	$R_{\theta JA}$	100	$^{\circ}C/W$
Junction to ambient ^{(a)(e)}	$R_{\theta JA}$	70	$^{\circ}C/W$
Junction to ambient ^{(b)(d)}	$R_{\theta JA}$	60	$^{\circ}C/W$

NOTES:

- (a) For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.
- (b) For a device surface mounted on FR4 PCB measured at $t \leq 10$ sec.
- (c) Repetitive rating - 25mm x 25mm FR4 PCB, $D=0.02$, pulse width 300 μ s - pulse width limited by maximum junction temperature.
- (d) For a dual device with one active die.
- (e) For a device with two active die running at equal power.

ZXMN6A11DN8

Typical characteristics



ZXMN6A11DN8

Electrical characteristics (at $T_{amb} = 25^{\circ}\text{C}$ unless otherwise stated)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Static						
Drain-source breakdown voltage	$V_{(BR)DSS}$	60			V	$I_D = 250\mu\text{A}$, $V_{GS} = 0\text{V}$
Zero gate voltage drain current	I_{DSS}			1.0	μA	$V_{DS} = 60\text{V}$, $V_{GS} = 0\text{V}$
Gate-body leakage	I_{GSS}			100	nA	$V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$
Gate-source threshold voltage	$V_{GS(th)}$	1.0			V	$I_D = 250\mu\text{A}$, $V_{DS} = V_{GS}$
Static drain-source on-state resistance ^(*)	$R_{DS(on)}$			0.120	Ω	$V_{GS} = 10\text{V}$, $I_D = 2.5\text{A}$
				0.180	Ω	$V_{GS} = 4.5\text{V}$, $I_D = 2\text{A}$
Forward transconductance ^{(*)(‡)}	g_{fs}		4.9		S	$V_{DS} = 15\text{V}$, $I_D = 2.5\text{A}$
Dynamic^(‡)						
Input capacitance	C_{iss}		330		pF	$V_{DS} = 40\text{V}$, $V_{GS} = 0\text{V}$ $f = 1\text{MHz}$
Output capacitance	C_{oss}		35.2		pF	
Reverse transfer capacitance	C_{rss}		17.1		pF	
Switching^(†) (‡)						
Turn-on-delay time	$t_{d(on)}$		1.95		ns	$V_{DD} = 30\text{V}$, $I_D = 2.5\text{A}$ $R_G = 6.0\Omega$, $V_{GS} = 10\text{V}$
Rise time	t_r		3.5		ns	
Turn-off delay time	$t_{d(off)}$		8.2		ns	
Fall time	t_f		4.6		ns	
Gate charge	Q_g		3.0		nC	$V_{DS} = 15\text{V}$, $V_{GS} = 5\text{V}$ $I_D = 2.5\text{A}$
Total gate charge	Q_g		5.7		nC	$V_{DS} = 15\text{V}$, $V_{GS} = 10\text{V}$ $I_D = 2.5\text{A}$
Gate-source charge	Q_{gs}		1.25		nC	
Gate drain charge	Q_{gd}		0.86		nC	
Source-drain diode						
Diode forward voltage ^(*)	V_{SD}		0.85	0.95	V	$T_j = 25^{\circ}\text{C}$, $I_S = 2.8\text{A}$, $V_{GS} = 0\text{V}$
Reverse recovery time ^(‡)	t_{rr}		21.5		ns	$T_j = 25^{\circ}\text{C}$, $I_S = 2.5\text{A}$, $di/dt = 100\text{A}/\mu\text{s}$
Reverse recovery charge ^(‡)	Q_{rr}		20.5		nC	

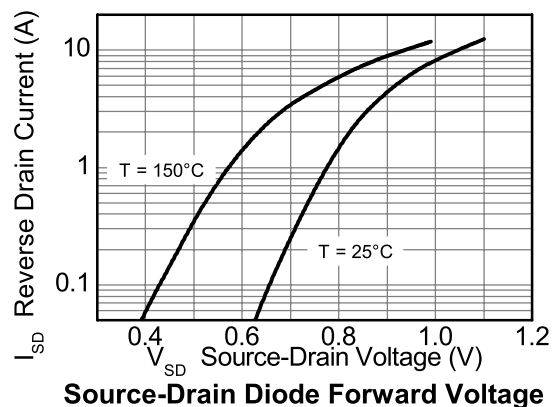
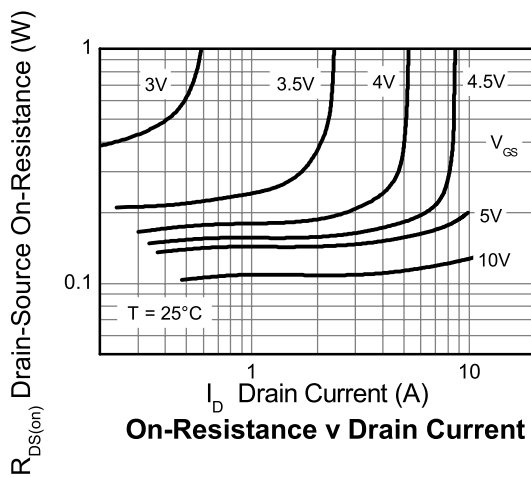
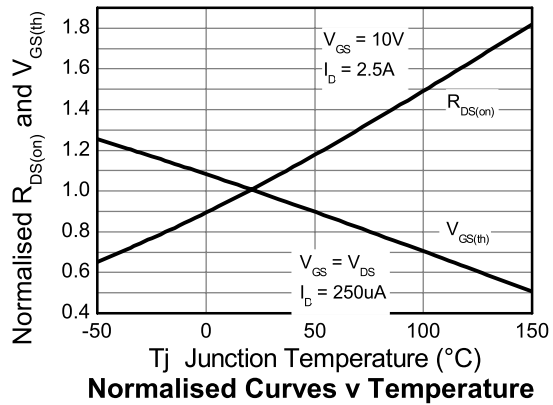
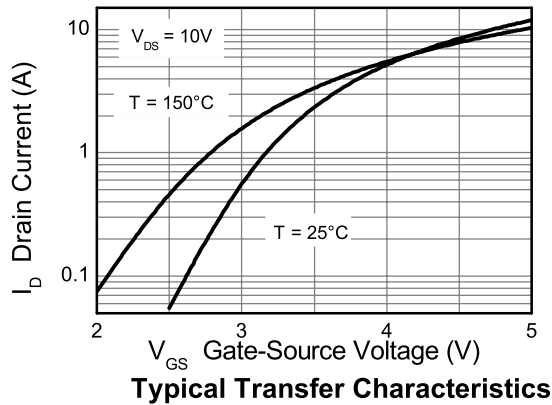
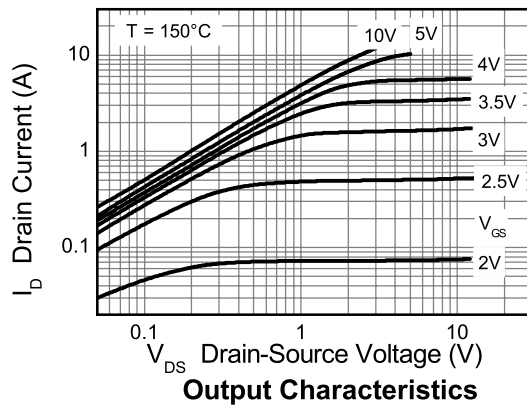
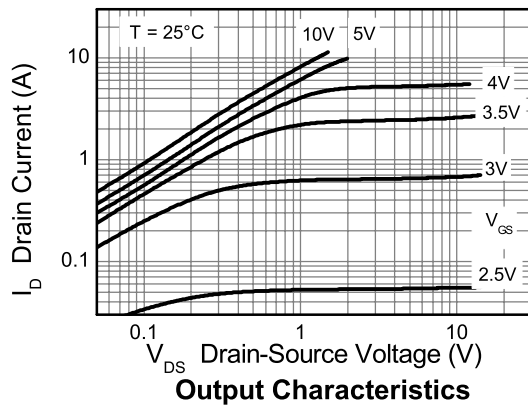
NOTES:

(*) Measured under pulsed conditions. Pulse width = $300\mu\text{s}$. Duty cycle $\leq 2\%$.

(†) Switching characteristics are independent of operating junction temperature.

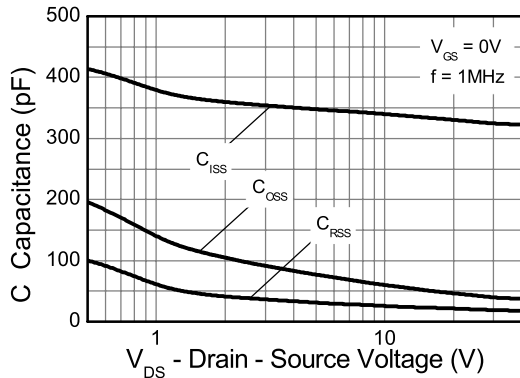
(‡) For design aid only, not subject to production testing.

Typical characteristics

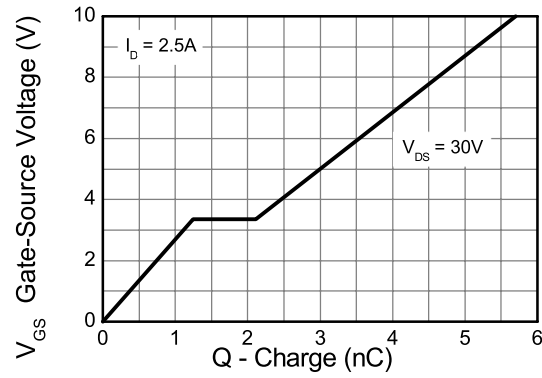


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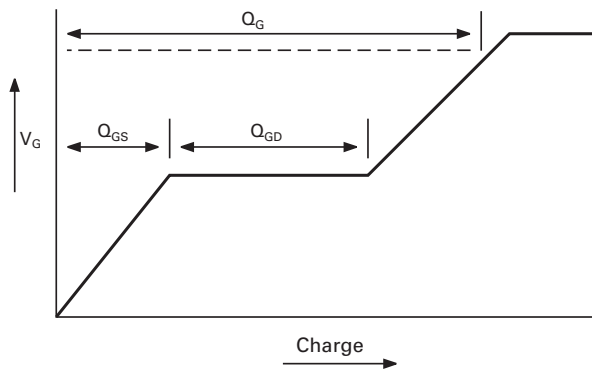
Typical characteristics



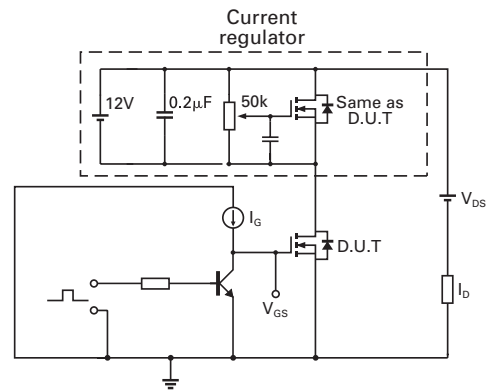
Capacitance v Drain-Source Voltage



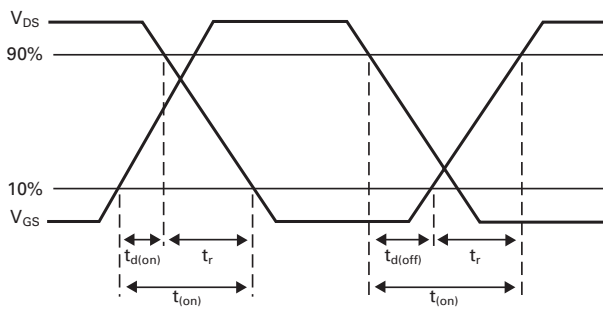
Gate-Source Voltage v Gate Charge



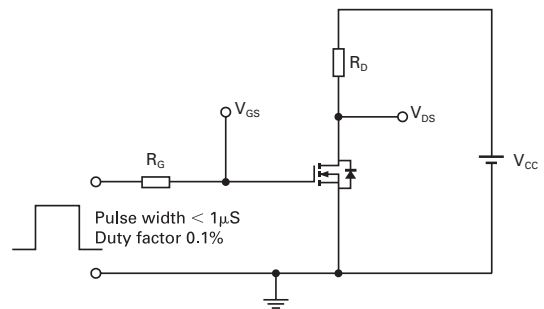
Basic gate charge waveform



Gate charge test circuit



Switching time waveforms



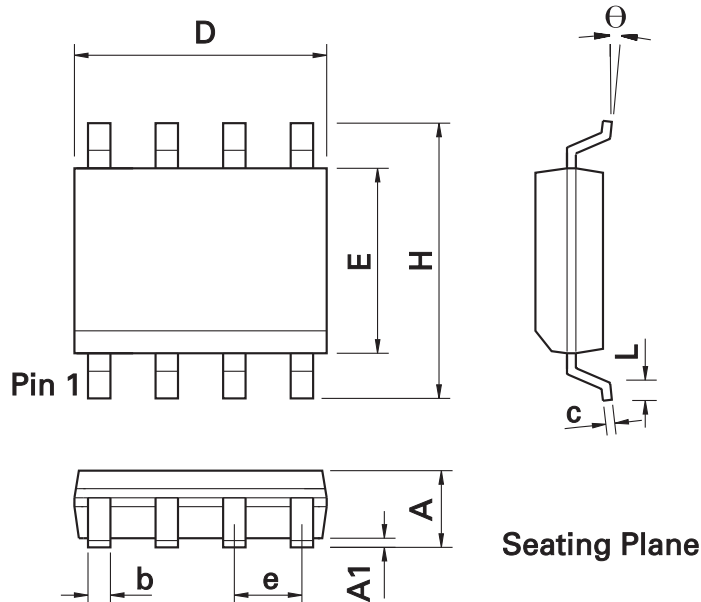
Switching time test circuit

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Package outline - SO8



DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.053	0.069	1.35	1.75	e	0.050 BSC		1.27 BSC	
A1	0.004	0.010	0.10	0.25	b	0.013	0.020	0.33	0.51
D	0.189	0.197	4.80	5.00	c	0.008	0.010	0.19	0.25
H	0.228	0.244	5.80	6.20	Θ	0°	8°	0°	8°
E	0.150	0.157	3.80	4.00	h	0.010	0.020	0.25	0.50
L	0.016	0.050	0.40	1.27	-	-	-	-	-

Note: Controlling dimensions are in inches. Approximate dimensions are provided in millimeters

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- Подбор аналогов;
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- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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